# FRIF M.

- Designed for Wide Channel IF Filtering
- Low Insertion Loss
- Hermetic 13.3 x 6.5 mm Surface-mount Case
- Balanced or Single Ended Input and Output
- Complies with Directive 2002/95/EC (RoHS)

## Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+13	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Suitable for lead-free soldering - Max. Soldering Profile	260°C for 30 s	



**SF1177A** 

57.6 MHz



### **Electrical Characteristics**

Characteristic		Sym	Notes	Min	Тур	Max	Units
Nominal Frequency		f <sub>N</sub>	1		57.6		MHz
Passband bandwidth	1dB	B <sub>W</sub>		21.2			MHz
Insertion Loss	47 68.2 MHz	1 <sub>L</sub>	4.0.0			15.0	dB
Rel. Attenuation to a <sub>max</sub>	0 29.8 MHz		1, 2,3	45			
	85.4 250 MHz	a <sub>rel</sub>		45			dB
	250 1000 MHz			35			
Amplitude ripple (p-p)	47 68.2 MHz	Δa	100			1.5	dB
Group delay ripple (p-p)	47 68.2 MHz	Δτ	1, 2, 3			50	ns
1 dB compression	47 68.2 MHz			12			dBm
Input IP3	47 68.2 MHz			30			dBm
Max. Input level (non-destructive)				13			dBm
Operating Temperature			1	-25		+85	°C
Terminating source impedance					50		Ohm
Terminating load impedance					50		Ohm

Impedance Matching to 50 $\Omega$ Unbalanced	External L-C
Case Style	SM13365-12 13.3 x 6.5 mm Nominal Footprint
Lid Symbolization (YY = year, WW = week)	RFM SF1177A YYWW

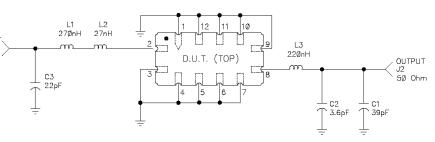
INPU1

5Ø 0hm

J1

### **Electrical Connections**

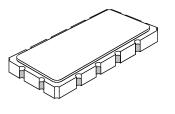
Connection	Terminals
Port 1 Hot	2
Port 2 Hot	8
Case Ground	All others



- Notes: 1. Unless noted otherwise, all specifications apply over the operating temperature in the statistical domonstration board with impedance range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
- 2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the pass-3. band. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details. Part to part absolute delay measurement records the absolute delay mean
- 4
- across 1 dB passband.
- "LRIP" or "L" after the part number indicates "low rate initial production" and 5. "ENG" or "E" indicates "engineering prototypes."
- 6. The design, manufacturing process, and specifications of this filter are subject to change.
- 7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit desian.
- 8. US and international patents may apply.
- 9. Electrostatic Sensitive Device. Observe precautions for handling.

## SM13365-12 Case

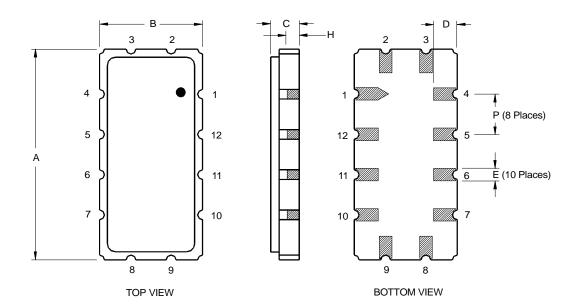
## 12-Terminal Ceramic Surface-Mount Case 13.3 x 6.5 mm Nominal Footprint



Case Dimensions						
Dimension	mm			Inches		
Dimension	Min	Nom	Max	Min	Nom	Max
Α	13.08	13.31	13.60	0.515	0.524	0.535
В	6.27	6.50	6.80	0.247	0.256	0.268
С		1.91	2.00		0.075	0.079
D		1.50			0.059	
E		0.79			0.031	
Н		1.0			0.039	
Р		2.54			0.100	

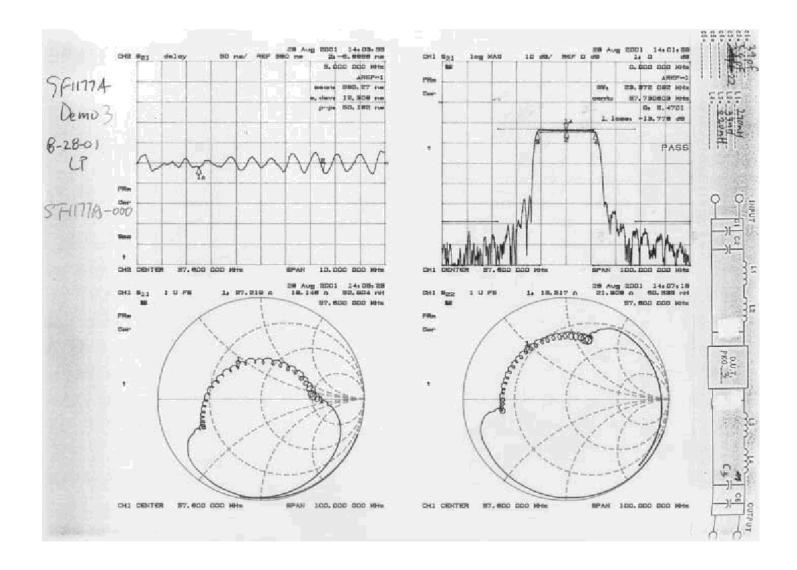
Materials					
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80- 200 ulnches (203-508 uM) Ni.				
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick				
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic				
Pb Free					

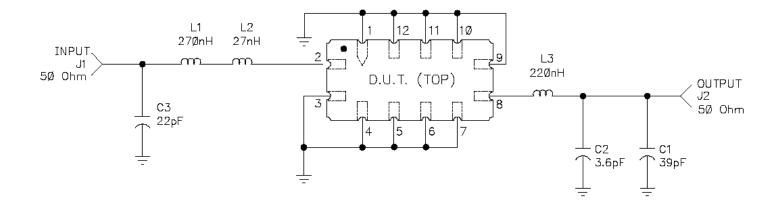
Electrical Connections				
	Connection	Terminals		
Port 1	Input or Return	2		
	Return or Input	3		
Port 2	Output or Return	8		
	Return or Output	9		
	Ground	All others		
Single Ended Operation		Return is ground		
Differential Operation		Return is hot		



## SAW Filter

57.6 MHz





E-mail: info@rfm.com http://www.rfm.com SF1177A-121604 NOTES:

- 1. SOLDER MOUNT COMPONENTS & CONNECTORS TO PCB1.
- 2. ORIENT THE FLTR1 AND SOLDER IT DOWN TO THE BOARD AS SHOWN.

